



# CALL FOR PAPERS

**ICTMP 2020**  
**Jan 30-31, 2020**  
**New York, USA**

The International Research Conference is a federated organization dedicated to bringing together a significant number of diverse scholarly events for presentation within the conference program. Events will run over a span of time during the conference depending on the number and length of the presentations.

ICTMP 2020 : International Conference on Thermoforming Methods and Processes is the premier interdisciplinary forum for the presentation of new advances and research results in the fields of Thermoforming Methods and Processes. The conference will bring together leading academic scientists, researchers and scholars in the domain of interest from around the world. Topics of interest for submission include, but are not limited to:

Thermoforming and thermoforming process  
Manufacturing and design  
Industrial engineering  
Thermoforming methods  
Thermoforming design  
Thermoplastic behavior  
Heating and cooling  
Thin-gauge and heavy-gauge thermoforming

Thermoforming mold making  
Vacuum thermoforming  
Pressure thermoforming  
Mechanical thermoforming  
Thermoforming applications  
Plastic fabrication in thermoforming  
Computational thermoforming and digital fabrication